



# SINGLE PHASE GLASS PASSIVATED BRIDGE RECTIFIER GBPC1502W

## GLASS PASSIVATED SINGLE-PHASE BRIDGE RECTIFIER

### Features

- Glass passivated chip junction
- Plastic package has underwriters laboratory
- Flammability classification 90V-0
- Integrally molded heatsink provide very low thermal resistance
- High isolation voltage from case to leads
- High forward surge current capability
- High temperature soldering guaranteed:  
260°C/10 seconds, 0.375"(9.5mm) lead length at 5lbs (2.3kg)tension



### Mechanical Data

<b>Case:</b>	Molded Plastic body
<b>Polarity</b>	Polarity symbols marked on case
<b>Terminals:</b>	Plate 0.060" (1.02mm) diameter
<b>Mounting torque</b>	/
<b>Mounting position:</b>	Thru hole for #10 screw, 20 in-lbs torque max
<b>Weight:</b>	1.02 ounce, 29 gram

### Maximum Ratings ( $T_{Ambient}=25^{\circ}C$ unless noted otherwise)

Symbol	Description	GBPC1502W	Unit	Conditions
VRRM	Max Recurrent Peak Reverse Voltage	200	V	
VRMS	Max RMS Voltage	140	V	
VDC	Max DC Blocking Voltage	200	V	
I(AV)	Max Average Forward Rectified Current	15.0	A	At TC= 55°C (note1,2)
IFSM	Peak Forward Surge Current	300	A	8.3ms single half sine-wave (JEDEC method)
TJ,TSTG	Operating and Storage Temperature Range	-55 to +150	°C	
I2t	Rating for Fusing	37	A2s	T<8.3mS

### Electrical Characteristics ( $T_{Ambient}=25^{\circ}C$ unless noted otherwise)

Symbol	Description	GBPC1502W	Unit	Conditions
VF	Max Instantaneous Forward Voltage	1.1	V	Drop per Bridge element 7.5A
IR	Max DC Reverse Current at Rated DC Blocking Voltage	10.0	µA	TA=25°C
		100		Tc=100°C
VISO	Isolation voltage from case to lead	2500	pF	
RJI	Typical Thermal Resistance	2.0	°C/W	Note 1 and Note 2

#### Note:

1. Bolt down on heatsink with silicon thermal compound between bridge and mounting surface for maximum heat transfer with #10 screw.
2. Unit mounted on 5.0" x 4.0" x 3.0" thick (12.8 x 10.2 x 7.3cm) Al Plate

# GBPC1502W

## RATINGS AND CHARACTERISTIC CURVES GBPC1502W

FIG.1-DERATING CURVE FOR OUTPUT RECTIFIED CURRENT

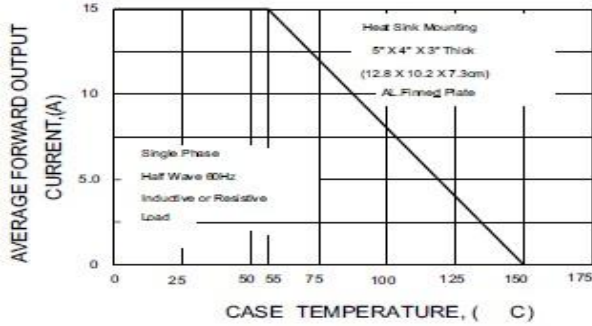


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PER ELEMENT

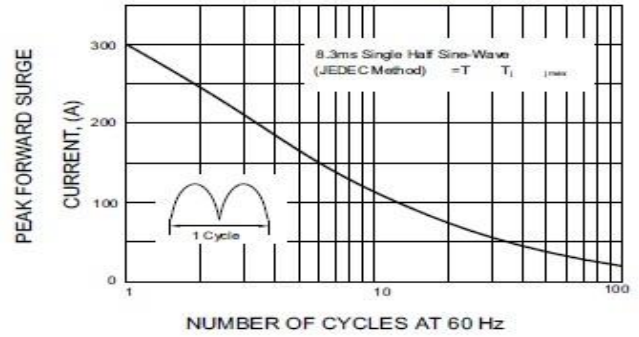


FIG.3-TYPICAL FORWARD CHARACTERISTICS PER BRIDGE ELEMENT

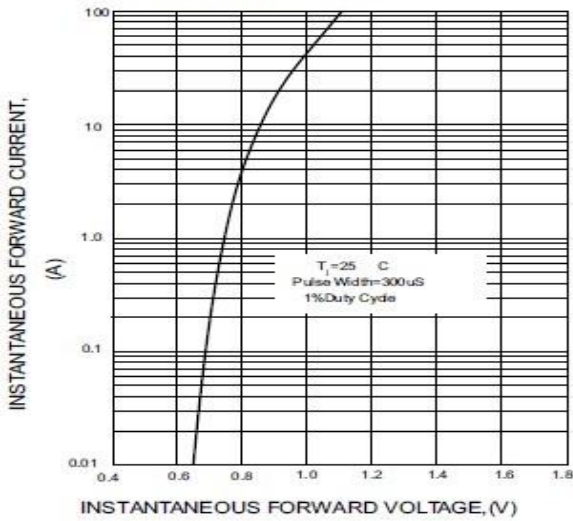


FIG.4-TYPICAL REVERSE CHARACTERISTICS PER BRIDGE ELEMENT

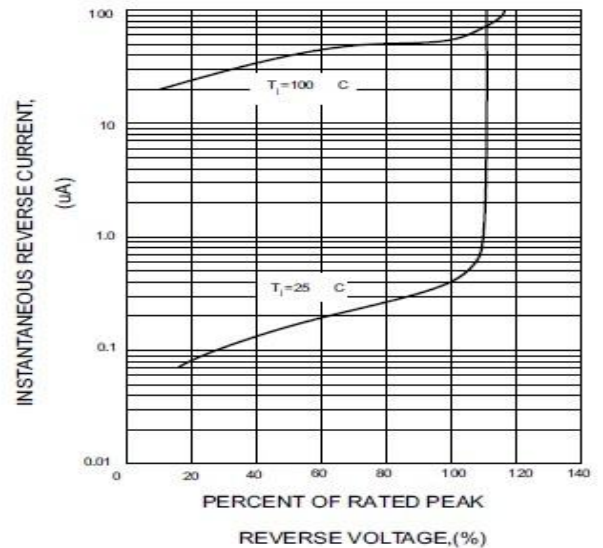


FIG.5-TYPICAL JUNCTION CAPACITANCE PER BRIDGE ELEMENT

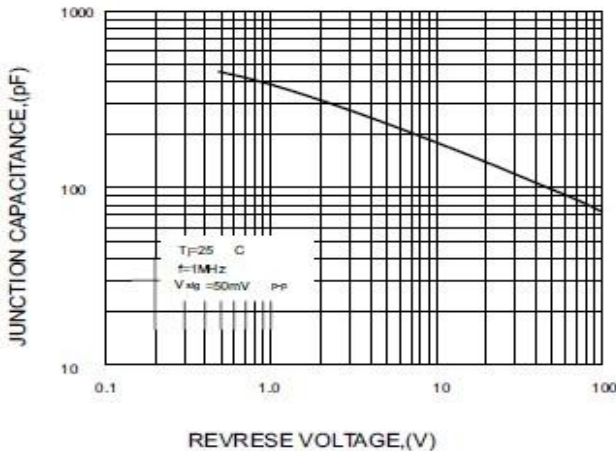
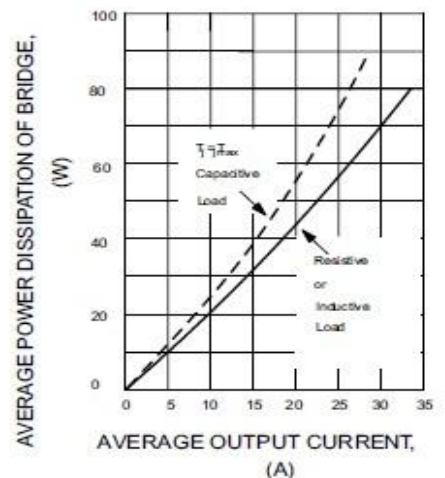
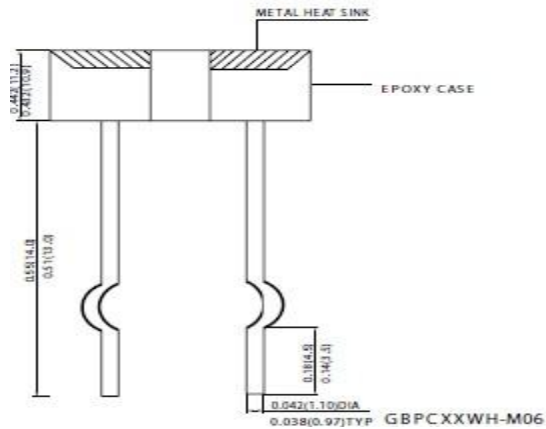
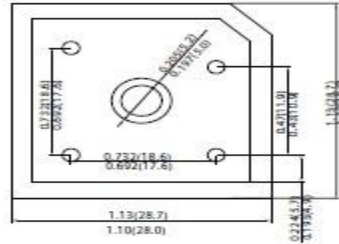


FIG.6-MAXIMUM POWER DISSIPATION



Dimensions in inches (mm)



Contact us:

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